

STGE50NC60VD

50 A - 600 V very fast IGBT

Features

- High current capability
- High frequency operation
- Low C_{RES}/C_{IES} ratio (no cross-conduction susceptibility)
- Very soft ultra fast recovery antiparallel diode

Applications

- High frequency inverters
- SMPS and PFC in both hard switching and resonant topologies
- UPS
- Motor drivers



Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESH™ IGBTs, with outstanding performances. The suffix "V" identifies a family optimized for high frequency.

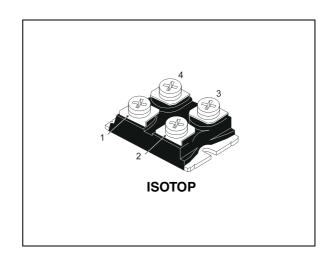


Figure 1. Internal schematic diagram

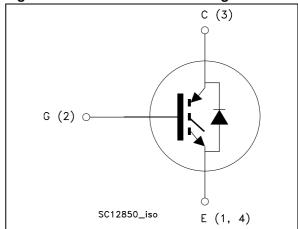


Table 1. Device summary

| Order code | Marking | Package | Packaging |
|--------------|------------|---------|-----------|
| STGE50NC60VD | GE50NC60VD | ISOTOP | Tube |

Contents STGE50NC60VD

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STGE50NC60VD Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

| Symbol | Parameter | Value | Unit |
|-------------------------------|--|------------|------|
| V _{CES} | Collector-emitter voltage (V _{GE} = 0) | 600 | ٧ |
| I _C ⁽¹⁾ | Collector current (continuous) at T _C = 25 °C | 90 | Α |
| I _C ⁽¹⁾ | Collector current (continuous) at T _C = 100 °C | 50 | Α |
| I _{CL} (2) | Turn-off latching current 200 | | Α |
| I _{CP} (3) | Pulsed collector current 200 | | Α |
| V _{GE} | Gate-emitter voltage ± 20 | | V |
| I _F | Diode RMS forward current at T _C =25°C | 30 | Α |
| I _{FSM} | Surge non repetitive forward current t _p = 10 ms sinusoidal | 120 | А |
| P _{TOT} | Total dissipation at T _C = 25 °C 260 | | W |
| Tj | Operating junction temperature | -55 to 150 | °C |

^{1.} Calculated according to the iterative formula

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2. $V_{clamp} = 80\%$ of V_{CES} , $T_j = 150$ °C, $R_G = 10 \Omega$, $V_{GE} = 15 V$
- 3. Pulse width limited by max. junction temperature allowed

Table 3. Thermal data

| Symbol | Parameter | Value | Unit |
|-----------------------|--|-------|------|
| R _{thj-case} | Thermal resistance junction-case IGBT | 0.48 | °C/W |
| R _{thj-case} | Thermal resistance junction-case diode | 1.6 | °C/W |
| R _{thj-amb} | Thermal resistance junction-amb | 30 | °C/W |

Electrical characteristics STGE50NC60VD

2 Electrical characteristics

(T_J = 25 $^{\circ}$ C unless otherwise specified)

Table 4. Static

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|--------------------------------|---|---|------|------|----------|----------|
| V _{(BR)CES} | Collector-emitter breakdown voltage (V _{GE} = 0) | I _C = 1 mA | 600 | | | ٧ |
| V _{CE(sat)} | Collector-emitter saturation voltage | V_{GE} = 15 V, I_{C} = 40 A V_{GE} = 15 V, I_{C} =40 A, T_{j} =125 °C | | 1.9 | 2.5 | V V |
| V _{GE(th)} | Gate threshold voltage | V _{CE} = V _{GE} , I _C = 250 μA | 3.75 | | 5.75 | V |
| I _{CES} | Collector cut-off current (V _{GE} = 0) | V _{CE} =600 V V _{CE} = 600 V, T _j = 125 °C | | | 150 1 | μA mA |
| I _{GES} | Gate-emitter leakage current (V _{CE} = 0) | V _{GE} = ±20 V | | | ±100 | nA |
| g _{fs} ⁽¹⁾ | Forward transconductance | $V_{CE} = 15 V_{,} I_{C} = 20 A$ | | 20 | | S |

^{1.} Pulsed: pulse duration= 300 μ s, duty cycle 1.5%

Table 5. Dynamic

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|--|---|--|------|--------------------|------|----------------|
| C _{ies} C _{oes} C _{res} | Input capacitance Output capacitance Reverse transfer capacitance | $V_{CE} = 25 \text{ V, f} = 1 \text{ MHz,}$ $V_{GE} = 0$ | - | 4550 350 105 | - | pF pF pF |
| Q _g Q _{ge} Q _{gc} | Total gate charge Gate-emitter charge Gate-collector charge | $V_{CE} = 390 \text{ V}, I_{C} = 40 \text{ A},$ $V_{GE} = 15 \text{ V},$ see Figure 17 | - | 214 30 96 | - | nC nC nC |

Table 6. Switching on/off (inductive load)

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---|---|--|------|------------------|------|------------------|
| t _{d(on)} t _r (di/dt) _{on} | Turn-on delay time Current rise time Turn-on current slope | V_{CC} = 390 V, I_{C} = 40 A R_{G} = 3.3 Ω , V_{GE} = 15 V, see <i>Figure 16</i> | - | 43 17 2060 | - | ns ns A/µs |
| t _{d(on)} t _r (di/dt) _{on} | Turn-on delay time Current rise time Turn-on current slope | $V_{CC} = 390 \text{ V, } I_{C} = 40 \text{ A}$ $R_{G} = 3.3 \Omega, V_{GE} = 15 \text{ V,}$ $T_{j} = 125 ^{\circ}\text{C}$ see <i>Figure 16</i> | - | 42 19 1900 | - | ns ns A/µs |
| t _{r(Voff)} t _{d(Voff)} t _f | Off voltage rise time Turn-off delay time Current fall time | V_{CC} = 390 V, I_{C} = 40 A R_{G} = 3.3 Ω , V_{GE} = 15 V, see <i>Figure 16</i> | - | 25 140 45 | - | ns ns ns |
| t _{r(Voff)} t _{d(Voff)} t _f | Off voltage rise time Turn-off delay time Current fall time | V_{CC} = 390 V, I_{C} = 40 A R_{G} = 3.3 Ω , V_{GE} = 15 V, T_{j} = 125 °C see <i>Figure 16</i> | - | 60 170 77 | - | ns ns ns |

Table 7. Switching energy (inductive load)

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|--|---|--|------|---------------------|--------------------|----------------|
| E _{on} ⁽¹⁾ E _{off} ⁽²⁾ E _{ts} | Turn-on switching losses Turn-off switching losses Total switching losses | V_{CC} = 390 V, I_{C} = 40 A R_{G} = 3.3 Ω , V_{GE} = 15 V, see <i>Figure 18</i> | - | 330 720 1050 | 450 970 1420 | µJ µJ µJ |
| E _{on} ⁽¹⁾ E _{off} ⁽²⁾ E _{ts} | Turn-on switching losses Turn-off switching losses Total switching losses | $V_{CC} = 390 \text{ V, } I_{C} = 40 \text{ A}$ $R_{G} = 3.3 \Omega, V_{GE} = 15 \text{ V,}$ $T_{j} = 125 ^{\circ}C$ see Figure 18 | - | 640 1400 2040 | | μJ μJ μJ |

Eon is the turn-on losses when a typical diode is used in the test circuit in Figure 18 If the IGBT is offered in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25 °C and 125 °C)

^{2.} Turn-off losses include also the tail of the collector current

Electrical characteristics STGE50NC60VD

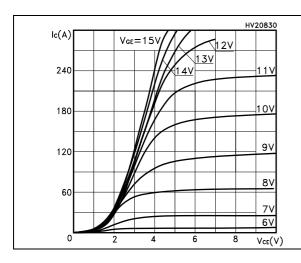
Table 8. Collector-emitter diode

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|--|--|--|------|------------------|------|---------------|
| V _F | Forward on-voltage | I _F = 20 A I _F = 20 A, Tj = 125°C | - | 1.5 1 | 2.2 | V V |
| t _{rr} Q _{rr} I _{rrm} | Reverse recovery time Reverse recovery charge Reverse recovery current | $I_F = 20 \text{ A}, V_R = 40 \text{ V},$ di/dt = 100 A/ μ s see <i>Figure 19</i> | - | 44 66 3 | | ns nC A |
| t _{rr} Q _{rr} I _{rrm} | Reverse recovery time Reverse recovery charge Reverse recovery current | $I_F = 20 \text{ A}, V_R = 40 \text{ V},$ $T_j = 125 ^{\circ}\text{C}, \text{di/dt} = 100 \text{A/}\mu\text{s}$ see <i>Figure 19</i> | - | 88 237 5.4 | | ns nC A |

2.1 Electrical characteristics (curves)

Figure 2. Output characteristics

Figure 3. Transfer characteristics



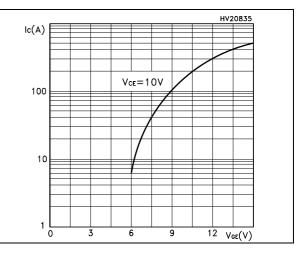
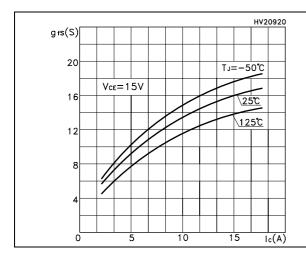


Figure 4. Transconductance

Figure 5. Collector-emitter on voltage vs temperature



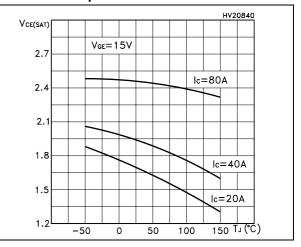
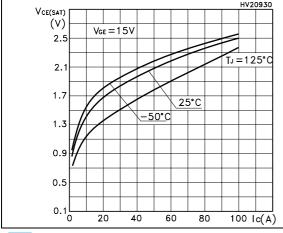
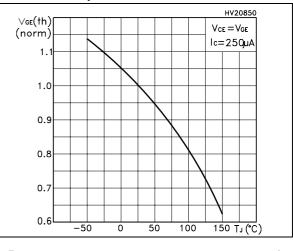


Figure 6. Collector-emitter on voltage vs collector current

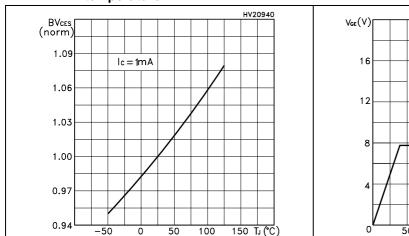
Figure 7. Normalized gate threshold vs temperature





Electrical characteristics STGE50NC60VD

Figure 8. Normalized breakdown voltage vs Figure 9. Gate charge vs gate-emitter voltage temperature



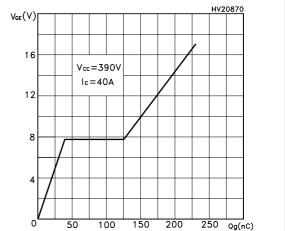
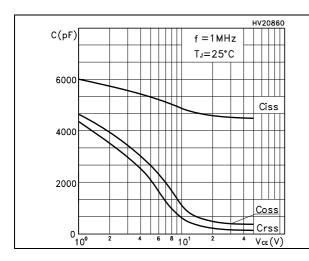


Figure 10. Capacitance variations

Figure 11. Total switching losses vs temperature



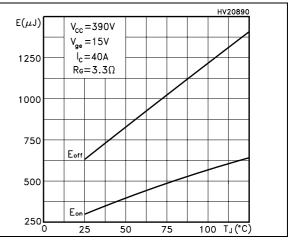
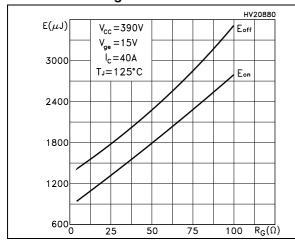


Figure 12. Total switching losses vs gate charge resistance

Figure 13. Total switching losses vs collector current



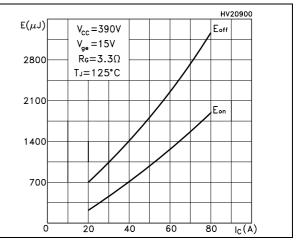
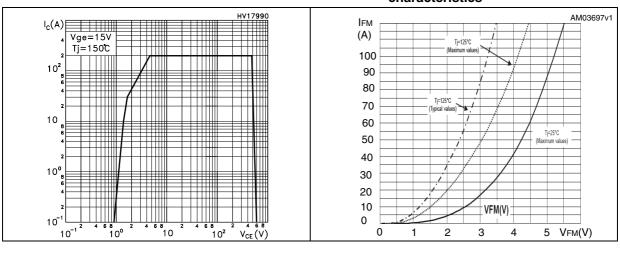


Figure 14. Turn-off SOA

Figure 15. Emitter-collector diode characteristics



Test circuits STGE50NC60VD

3 Test circuits

Figure 16. Test circuit for inductive load switching

Figure 17. Gate charge test circuit

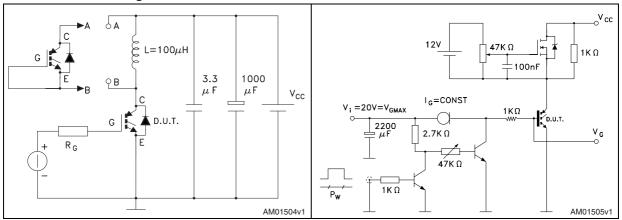
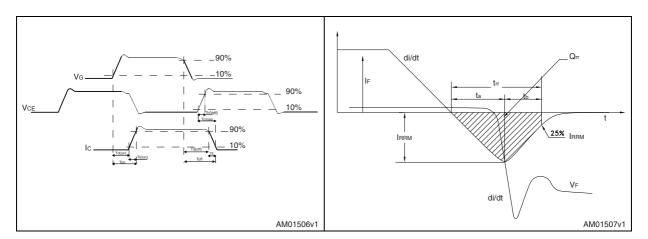


Figure 18. Switching waveform

Figure 19. Diode recovery time waveform



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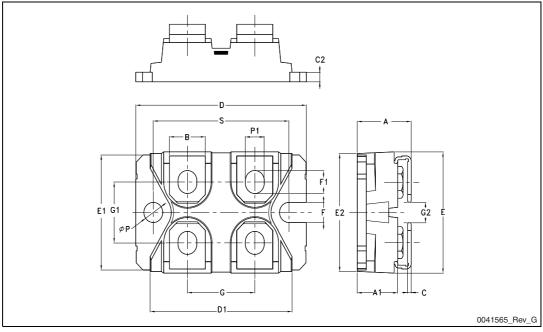
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Table 9. ISOTOP mechanical data

| Dime | | mm | | |
|------|-------|-------|-------|--|
| Dim. | Min. | Тур. | Max. | |
| Α | 11.80 | | 12.20 | |
| A1 | 8.90 | | 9.10 | |
| В | 7.80 | | 8.20 | |
| С | 0.75 | | 0.85 | |
| C2 | 1.95 | | 2.05 | |
| D | 37.80 | | 38.20 | |
| D1 | 31.50 | | 31.70 | |
| E | 25.15 | | 25.50 | |
| E1 | 23.85 | | 24.15 | |
| E2 | | 24.80 | | |
| G | 14.90 | 15.10 | | |
| G1 | 12.60 | | 12.80 | |
| G2 | 3.50 | | 4.30 | |
| F | 4.10 | | 4.30 | |
| F1 | 4.60 | | 5 | |
| φР | 4 | | 4.30 | |
| P1 | 4 | | 4.40 | |
| S | 30.10 | | 30.30 | |

Figure 20. ISOTOP drawing



STGE50NC60VD Revision history

5 Revision history

Table 10. Document revision history

| Date | Revision | Changes |
|-------------|----------|--|
| 11-Oct-2006 | 1 | First release |
| 24-Jul-2007 | 2 | Internal schematic diagram has been updated Figure 1 |
| 23-Apr-2009 | 3 | Updated: mechanical data |

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